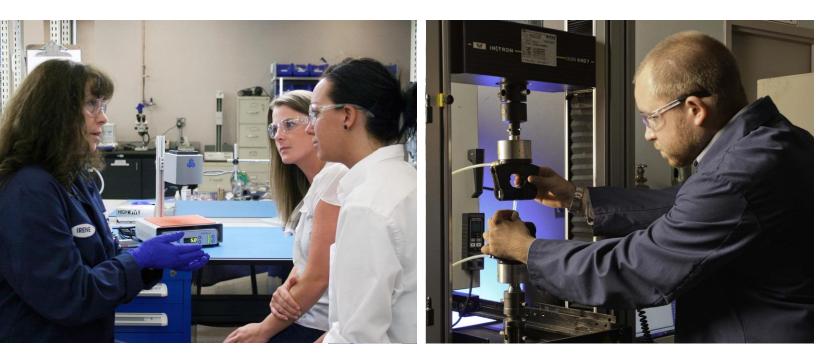


Electronics Assembly

UV Light-Curable Adhesives, Coatings, and Encapsulants for Electronic Assembly





The Dymax Edge

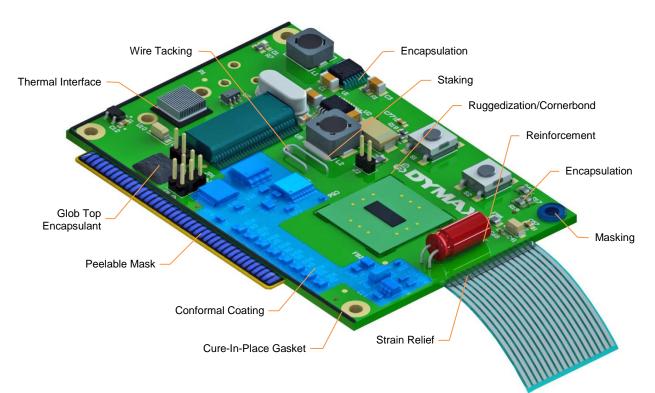
Oligomers. Adhesives. Coatings. Equipment. One priceless resource. That's the Dymax Edge.

At Dymax, we're committed to providing our customers with the solutions they need for their specific application challenges. Inherent in the Dymax Edge approach is the commitment to view a customer's challenge differently by listening, focusing, and using an entire toolbox of resources and expertise to deliver the most efficient solution. This expertise isn't limited to the formulation of chemistry or the calibration of a machine. Rather, it's defined by a depth and breadth of knowledge that allows us to devise innovative solutions based on an optimal balance of material, chemistry, and equipment. The Dymax Edge is more than the combined resources of product, technology, and service. It's the fundamental belief that you best serve a customer when you look at the need from their perspective, not yours.



Dymax Materials for Electronics Assembly

Dymax one-part, solvent-free, UV light-curable electronic materials cure in seconds upon exposure to UV/Visible light and can be used in a wide variety of applications for circuit protection and electronic assembly. The products are electrically insulating and are designed for various operations including conformal coating, encapsulation, bonding, keypad coatings, thermal management, masking, and display bonding and lamination. Most products are available in multiple-viscosity grades, so the material flow may be tailored to the individual application. For shadowed areas, several cure options are available, including Dual-Cure light/moisture cure and Multi-Cure[®] light/heat cure technologies. IPC approved, MIL-I-46058C, and UL listed self-extinguishing grades are also available.



Environmental Benefits of Dymax Light-Curable Materials

Dymax understands that safe, ecologically friendly products benefit our customers, the environment, and us. We have created materials with attributes that lower product costs, life-cycle costs, and ecological impact. These attributes include:

- Solvent-free materials
- Halogen-free materials
- RoHS compliance
- REACH no substance of very high concern (SVHC)
- Eco-friendly, one-component materials



Dymax Halogen-Free conformal coatings, encapsulants, and adhesives are documented by an independent laboratory to meet or exceed standards set forth in IEC 61249-2-21. This international directive defines halogen-free as <900 ppm for chlorine, <900 ppm for bromine and <1,500 ppm total level of both combined. The current test method used for certification is BS EN 14582:2007.

Solvent Free

Conformal Coatings

Reliable Board Protection in Seconds

Product Number*	Description	Nominal Viscosity (cP)	Durometer Hardness	Modulus of Elasticity MPa [psi]	Dielectric Strength (Volts/mil)	Approvals	Halogen Free?
9481-E	 Room-temperature secondary moisture cure for shadowed areas Highest chemical and abrasion resistance Low viscosity for thin coatings 	125	D75	150 [21,800]	>1,500	MIL-I-46058 listed IPC-CC-830 approved UL recognized	HALOGEN
9482	 Room-temperature secondary moisture cure for shadowed areas Superior re-workability Chemical and thermal shock resistance 	1,100	D70	275 [40,000]	1,100	_	HALOGEN
984-LVUF	 Isocyanate free Rigid for high chemical and abrasion resistance Secondary heat cure for shadowed areas 	150	D80	410 [60,000]	1,800	MIL-I-46058 listed IPC-CC-830 approved UL recognized	HALOGEN
987	 Isocyanate free High chemical and abrasion resistance Secondary heat cure for shadowed areas 	150	D85	900 [130,000]	>1,500	MIL-I-46058 listed IPC-CC-830 approved	HALOGEN
9-20351-UR	 Isocyanate free Easy one-pass coverage of high-profile leads and tall components without seeping into shadowed areas Secondary heat cure for shadowed areas 	13,500	D60	19 [2,700]	500	_	HALOGEN FREE
9-20557	 Isocyanate free Medium viscosity for wetting components Low modulus for thermal cycling performance Secondary heat cure for shadowed areas 	2,300	D60	89 [13,000]	>1,500	MIL-I-46058C listed IPC-CC-830 approved UL recognized	HALOGEN
9-20557-LV	 Isocyanate free Low viscosity for thin coatings Low modulus for enhanced thermal cycling performance Secondary heat cure for shadowed areas 	850	D70	379 [55,000]	>1,500	MIL-I-46058C listed IPC-CC-830 approved	HALOGEN

*Other grades are available for specific applications requiring physical properties different from standard products listed here.

NOTE: Consult Dymax Conformal Coating Validation Report for more detailed information on conformal coatings.



Blue Fluorescing Coatings

Ultra-Red™ Fluorescing Coatings



Coatings with Secondary Heat or Moisture Cure

- Solvent free
- Tack-free UV cures in seconds
- Excellent environmental resistance
- Black grades available
- Adhesion to flex circuit substrates (FPC)
- Low stress under thermal cycling
- Rigid and flexible coatings available
- Variety of available viscosities

Thermal Interface Adhesives

Efficient Thermal Transfer Between Heat Sinks and Electronics

Product Number	Description	Applications	Thermal Conductivity	Nominal Viscosity (cP)	Halogen Free?
9-20801	 Light cure in seconds Secondary activator or heat cure for shadowed areas* Highly thixotropic for optimal placement 	 Mounting heat sinks on PCBs LED heat dissipation 	0.9 W/m*K	110,000	HALOGEN

*Dymax 501-E is the recommended activator for shadowed areas



Bonding Heat Sinks

- Sets in seconds with light exposure
- Cure shadow areas with activator or heat
- High-strength bonds

- Low stress for mismatched CTE's
- Room-temperature storage and cure

Chip Encapsulants and Wire Bonders

For Superior Protection on Flexible and Rigid Platforms

Product Number	Description	Applications	Durometer Hardness	Nominal Viscosity (cP)	Elongation at Break (%)	Modulus of Elasticity MPa [psi]	Halogen Free?			
9001-E-v3.1	 UV/Visible light cure for fastest processing 	 Chip-on-board Chip-on-flex 		4,500						
9001-E-v3.5	 Secondary heat cure for shadowed areas Multiple viscosities available for 	Chip-on-glassWire bonding	D45	17,000	150	17 [2,500]	HALOGEN			
9001-E-v3.7	optimal flow and coverage Low modulus for wire bonding	 Bare-die encapsulation 		50,000						
9008	 Flexible Highly moisture-resistant bonds to diverse surfaces such as polyimide, DAP, glass, epoxy board, metal, PET High adhesion, even at -40°C 	 Chip-on-flex encapsulation Flex circuit bonding and attachment to PCB and glass 	A85	4,500	300	_	HALOGEN			
9101	 UV/Visible light cure with secondary 	Chip-on-board		7,000	38	17.5 [2,550]				
9102	moisture cure Flexible	Chip-on-flex	Chip-on-glass	· ·		D30-D50	17,000	34	18.4 [2,670]	HALOGEN
9103	 Moisture and thermal resistance 				25,000	36	17.6 [2,560]			





Secondary Heat or Moisture Cure

eat Chip ure Encapsulants

Flex Circuit Encapsulants/ Wire Bonding

Black

Encapsulants

- 100% solvent free
- Instant UV/Visible cures
- High ionic purity
- Tenacious adhesion to flex circuit substrates (polyimide and PET)
- Low stress under thermal cycling
- Electrically insulating
- Electrically insulating
- Room-temperature storage
- Thermal shock and moisture resistance

Ruggedization

Photocurable Technology Offers Lower Costs and Increased Productivity

Product Number	Description and Applications	Nominal Viscosity (cP)	Durometer Hardness	Tensile @ Break MPa [psi]	Cure Depth mm [in]	Halogen Free?
9309-SC	 Highly thixotropic Formulated with See-Cure technology for easy visual confirmation of full cure 	45,000	D57	22 [3,000]	6.5 [0.26]	HALOGEN
9422-SC	 Highly thixotropic for optimal placement and wetting of components Formulated with See-Cure technology for easy visual confirmation of full cure 	38,000	D50	16 [2,300]	6.5 [0.26]	HALOGEN



Ruggedizing

Leadless Component Edgebonding/ Cornerbonding

- Fast dispense and cure
- Simple visual inspection (See-Cure blue-to-colorless change)
- Reduce stress on interconnects during push, pull, shock, drop, and vibration
- Easy rework

Holds shape after dispense

Fluorescing and blue grades

One part

- Improved bond strength for die and pry testing
- Engineered bead shape for wetting both board surface and component edge without seeping into shadowed area
- Jettable

Removable Masks

Product Number	Description and Applications	Cure Depth (mm [in])	Durometer Hardness	Cure Speed* (sec)	Viscosity (cP)	Halogen Free?
9-20479-B	 Peelable Wave-solder resistant Blue Excellent viscosity for machine dispensing 	6.4 [0.25]	A70	10	150,000	HALOGEN
9-318-F	PeelableFluoresces for easy inspectionVery fast curing	6.4 [0.25]	A55	<4	50,000	HALOGEN

*Cure speed depends on the intensity and distance from the light source. Cure speed was measured at an intensity of 175 mW/cm².







- 100% solids
- UV/Visible cure in seconds
- No ionic contamination

Fluorescing Mask

Mask

Removable

Peelable Mask

Acrylated Urethane Potting and Sealing

For Shallow Potting in 10-30 Seconds or Less – Highest Adhesion to Substrates

Product Number	Description and Applications	Recommended Substrates	UV Cure* Speed (sec)/ Depth (mm [in])	Durometer Hardness	Nominal Viscosity (cP)	Halogen Free?
921-T	Connectors, thermal switches Tamperproofing	ABS, filled nylon, metal, glass	30/6.4 [0.25]	D75	3,500	HALOGEN FREE
921-VT					11,000	
921-Gel	 Translucent bonds with high adhesion 				25,000	
9001-E V3.1	SensorsFlexible	ABS, PC, PVC, FR-4, metals			4,500	HALOGEN
9001-E V3.5			15/6.4 [0.25]	D45	17,000	
9001-E V3.7	 Excellent adhesion to engineering plastics 				50,000	

*UV cure speed depends on the intensity reaching the surface of the resin. Cure speed was measured at an intensity of 175 mW/cm².





Deep Layer

Potting



Cable Potting

Chip Potting

Full UV/Visible cure in seconds

- Solvent free
- High adhesion to substrates
- Flexible and rigid products available

LED Encapsulating

Bonding, Potting, and Sealing in Seconds

Product Number	Description	Applications	Linear Shrinkage (%)	Nominal Viscosity (cP)	Halogen Free?
LIGHT-CAP [®] 9622	 UV/Visible light cure in seconds No mixing required Heat resistant to 100°C Resistant to long-term UV exposure High light transmittance Durometer between silicone and epoxy 	 Instant casting of LEDs Rapid forming of protective optical lens 	0.79	12,000	HALOGEN



LED Airport Flight Display

LED Light

One component, no mixing required

- Enhances light transmittance
- Resistant to heat-induced yellowing
- Fast cure
- Solvent free
- Optically clear

Display Bonding and Laminating

Product Number	Description	Applications	Volumetric Shrinkage (%)	Nominal Viscosity (cP)	HalogenFre e?
9701	 Excellent re-workability Good thermal shock resistance Low shrinkage Non-yellowing 	Optical display lamination and touch screen bonding	4.9	200	HALOGEN
9702	 Excellent re-workability Good thermal shock resistance Low shrinkage Non-yellowing 	Optical display lamination and touch screen bonding	4.2	950	HALOGEN
9703	 Excellent re-workability Good thermal shock resistance Low shrinkage Non-yellowing 	Optical display lamination and edge damming	4.2	30,000	HALOGEN FREE



Touch Screen Lamination with 9700-Series Adhesives



Touch Screen or Cover Window Optical Bonding

- One component, no mixing required
- Flexible
- Resistant to yellowing
- Fast cure
- Bonds various substrates
- High optical clarity

Wire Tacking

Photocurable Technology Offers Lower Costs and Increased Productivity

Instant UV cure

Solvent free

Unlimited pot life

One part

Product	Description	Nominal	Durometer	Tensile @ Break	Halogen
Number		Viscosity (cP)	Hardness	MPa [psi]	Free?
9-911 Rev A	 On-demand cure for optimal positioning Exposed areas cure in seconds for immediate strength 	36,000	D80	28 [4,000]	HALOGEN



Wire Tacking

- Fluorescing additive for in-line quality control
- Excellent adhesion to solder masks and wires
- Thermal shock and moisture resistance

Dymax Adhesive Technologies

See-Cure Technology

Dymax light-curable adhesives with patented See-Cure technology have built-in cure validation that makes it easy for operators or simple automated inspection equipment to confirm cure without investing in additional specialized equipment. See-Cure technology is an indicator of cure that intentionally transitions the color of the adhesive after it has cured and builds a visible safety factor into the assembly process.

Ultra-Red[™] Fluorescing Technology

Ultra-Red[™] fluorescing technology, formulated into Dymax adhesives, enhances bond-line inspection processes and product authentication. The adhesives remain clear until exposed to low-intensity UV light at which point they fluoresce bright red. This is particularly effective while bonding plastics that naturally fluoresce blue, such as PVC and PET. Ultra-Red technology also produces a unique spectral signature that can be used by manufacturers for product authentication.

Multi-Cure[®] Light/Heat-Cure Technology

Multi-Cure adhesives combine the high-speed cure of UV or UV/Visible light with secondary cure mechanisms that enhance polymerization. Secondary cure mechanisms, which include thermal (heat) cure or activator cure, are useful when light can only reach a portion of the bond line, or when tacking a part prior to thermal cure to allow easier handling and transport during the manufacturing process.

Dual-Cure Light/Moisture-Cure Technology

Dual-Cure coatings are formulated to ensure complete cure in applications where shadowed areas on high-density circuit boards are a concern. Previously, areas shadowed from light were managed by selective coating – eliminating the need to cure in shadowed areas – or a secondary heat-cure process. Shadowed areas cure over time with moisture, eliminating the need for that second process step or concerns of component life degradation due to temperature exposure.

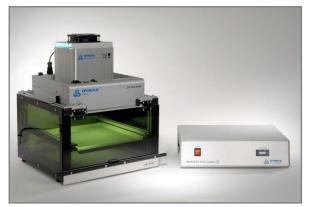
LED Light-Curable Adhesives

Dymax offers specially formulated LED light-curable adhesives for use with Dymax LED UV/Visible light-curing systems. The adhesives range from fast to ultra-fast cure speeds in order to accommodate specific electronic assembly needs.

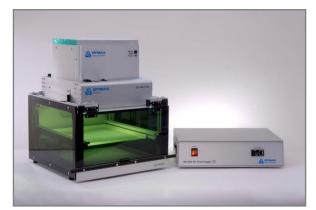


Flood Chambers and Conveyor Curing Systems for Electronic and Photonic Applications

Successful UV processing demands that the curing equipment be matched to the resin to optimize both performance and cost savings. Dymax manufactures UV light-curable resins and UV light-curing equipment and specializes in the optimization of UV light-curing processes. Our technical specialists are ready to help you optimize your process, and maximize your profit and product performance. For resin and equipment selection assistance please contact Dymax Application Engineering.



Dymax 5000 Flood Lamp Systems <u>Most Popular and Versatile</u> Ideal for potting, sealing, and encapsulating applications



Dymax 2000 Flood Lamp Systems Largest Cure Area Ideal for LED and masking applications

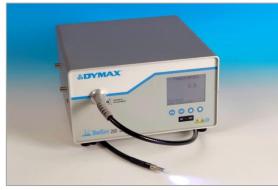


Dymax UVCS Series UV Curing Conveyor Systems with 5000-EC Lamps Ideal for conformal coating applications



Dymax Heavy-Duty UV Curing WIDECURE Conveyor Systems Ideal for curing adhesives, coatings, and inks

UV Light-Curing Spot Lamps for Electronic and Photonic Applications



Dymax BlueWave[®] 200 Version 3.0 UV-Curing Spot Lamp Ideal for fastest processing of small curing areas



Dymax BlueWave[®] LED Prime UVA Visible Spot Light-Curing System Ideal for cool spot curing coatings



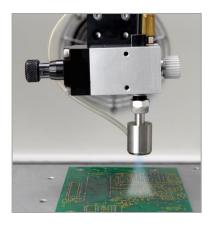
Liquid Lightguides Come in an assortment of sizes and split wand configurations



ACCU-CAL[™] 50 Radiometer Ideal for process monitoring

Dispensing Systems

Dymax has developed high-quality, field-proven dispense systems to fit many types of adhesive and fluid dispensing applications. These systems include various automated and manual dispensing valves, spray valves and guns, controllers, material reservoirs, and related components for seamless integration into assembly processes. The systems provide accurate, consistent dispense for a range of low- to high-viscosity fluids. Dispensing systems with adjustable suck-back control and dispensing valves that offer contaminate-free dispensing are available.





Reduced environmental impact and energy conservation are core pillars of the Dymax mission. Over the last 30 years, Dymax light-curable materials and curing equipment have become the industry standard for fast, environmentally conscious assembly. Dymax products replace technologies that contain hazardous ingredients, produce waste, or require higher amounts of energy to process. Dymax understands that safe ecologically friendly products benefit our customers, the environment, and us. We have created materials with attributes that lower product costs, life-cycle costs, and ecological impact.

Dymax Eco underlines the Dymax commitment to the environment. Information for Environmental Health and Safety officers, government officials, and engineers to assist in making informed decisions when comparing assembly processes is available by visiting <u>www.dymax.com/eco</u>.



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